2SD1280

Silicon NPN epitaxial planar type

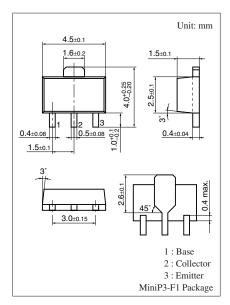
For low-voltage type medium output power amplification

Features

- Low collector-emitter saturation voltage $V_{CE(sat)}$
- Satisfactory operation performances at high efficiency with the low-voltage power supply.
- Mini power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

ADSolute Maximum Ratings $T_a = 25$ C						
Parameter	Symbol	Rating	Unit			
Collector-base voltage (Emitter open)	V _{CBO}	20	V			
Collector-emitter voltage (Base open)	V _{CEO}	20	V			
Emitter-base voltage (Collector open)	V _{EBO}	5	V			
Collector current	I _C	1	А			
Peak collector current	I _{CP}	2	А			
Collector power dissipation *	P _C	1	W			
Junction temperature	Tj	150	°C			
Storage temperature	T _{stg}	-55 to +150	°C			

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: R

Note) *: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

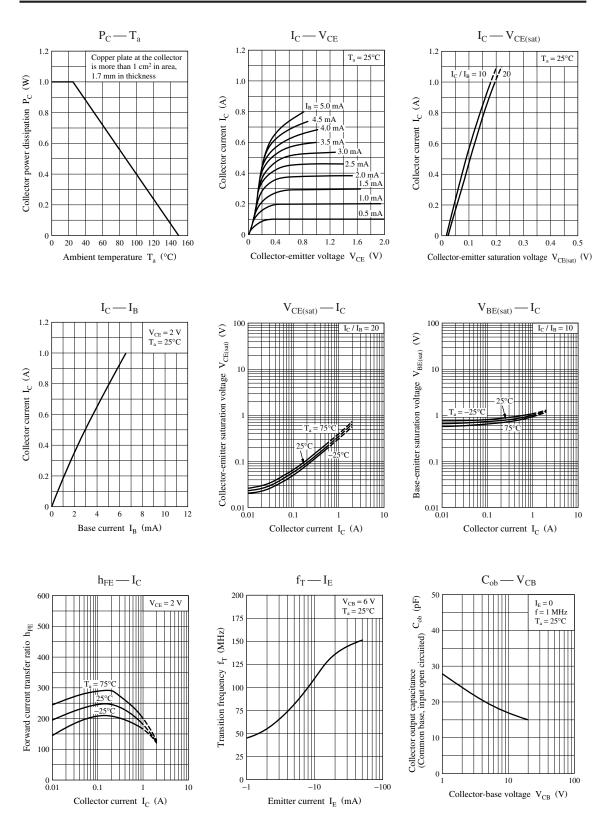
Parameter	Symbol	Conditions M		Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$	20			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 10 V, I_E = 0$			1	μΑ
Forward current transfer ratio	h _{FE1} *	$V_{CE} = 2 V, I_C = 0.5 A$	90		280	—
	h _{FE2}	$V_{CE} = 2 V, I_C = 1.5 A$	50			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 1 \text{ A}, I_{\rm B} = 50 \text{ mA}$			0.5	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$			1.2	V
Transition frequency	f _T	$V_{CB} = 6 V, I_E = -50 mA, f = 200 MHz$		150		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 6 V, I_E = 0, f = 1 MHz$		18		pF
(Common base, input open circuited)						

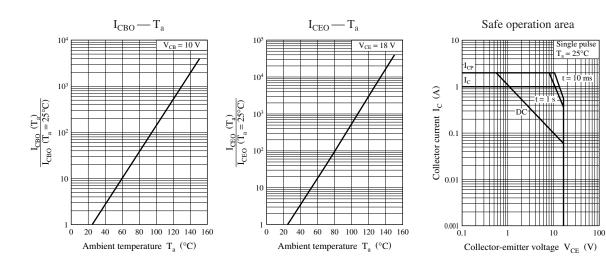
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	Q	R	S
h _{FE1}	90 to 155	130 to 210	180 to 280

Panasonic





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